## **Features**

- AEC-Q100 qualified constant current power module with integrated shielded inductor
- 36VDC input voltage buck regulator
- 1.5A output current with 0-100% PWM dimming
- SCP, OCP, OTP, and UVLO protection
- 3.0 x 5.0mm low profile QFN package
- Enable, fault, thermal shutdown & soft start functions
- -40 to 125°C operating temperature



Power

Module

The RPY-1.5Q is an automotive grade constant current source buck regulator designed for driving high power LEDs. The integrated inductor means that a complete LED driver can be realized in a compact 3mm x 5mm x 1.6mm thermally-enhanced QFN package with a maximum current output of up to 1500mA set with an external sense resistor. The input voltage range is from 4 to 36VDC, allowing 5V, 12V, or 24V supply voltages to be used. The output is fully protected against continuous short-circuits, input undervoltage, output overcurrent, or over-temperature conditions. A fault indicator flags thermal shutdown or LED open/short circuit conditions. Applications include dimmable LED lighting, visible or IR LED illumination for drones and robotic camera systems, or precision high current CC sources for test and measurement use.

Selection Guide					
Part Number	Input Voltage Range [VDC]	Output Voltage [VDC]	Output Current [mA]	Efficiency typ. <sup>(1)</sup> [%]	
RPY-1.5Q	4 - 36	0.8 - 34.8	0-1500	95	

Notes:

Note1: Tested at  $V_{IN}$ = 36VDC,  $V_{CTRL/DIM}$ = 2VDC,  $V_{OUT}$ = 2x 3VDC or 2 series LED,  $I_{OUT}$ = 1.5A,  $f_{sw}$ = 2.2MHz



## **RPY-1.5Q**

## 1.5 Amp QFN Package

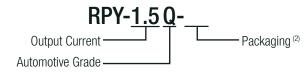








#### **Model Numbering**



Notes:

Note2: Add suffix "-R" for tape and reel packaging

Add suffix "-CT" for bag packaging (refer to "PACKAGING INFORMATION")

## **Specifications**

Parameter	Symbol	Min.	Тур.	Max.
	$V_{IN}$	-0.3VDC		40VDC
	$V_{\text{CTRL/DIM}}$	-0.3VDC		6VDC
Abaduta Mayimum Valtaga	$V_{\text{SW}}$	-0.3VDC		V <sub>IN</sub> + 0.3VDC
Absolute Maximum Voltage	$V_{\text{OUT}}$	-0.3VDC		$V_{IN} + 0.3VDC$
	$V_{BST}$	-0.3VDC		V <sub>SW</sub> + 6VDC
	others	-0.3VDC		6VDC
Maximum Continuous Power Losses (3)	$@T_{AMB} = 25^{\circ}C$			2.7W
Junction Temperature	TJ			150°C
Lead Temperature				260°C
Storage Temperature		-65°C		+150°C

Notes:

Note3: Maximum power losses = (150-Tamb)/46. Exceeding this value will activate thermal protection.



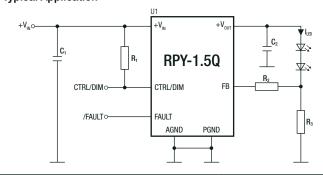


## **Series**

## Specifications

OPERATING CONDITIONS (V <sub>IN</sub> = 36VDC, I <sub>OUT</sub> = 1.5A T <sub>AMB</sub> = +25°C; tested with RECOM evaluation module: RPY-1.5Q-EVM-1 unless otherwise stated)				
Parameter	Condition	Min.	Тур.	Max.
Input Voltage Range		4VDC		36VDC
V. Haday valtaga Laglavit Throphold	DC-DC ON	3.2VDC	3.5VDC	3.8VDC
V <sub>IN</sub> Under-voltage Lockout Threshold	DC-DC OFF	2.8VDC	3.1VDC	3.4VDC
V <sub>IN</sub> Under-voltage Lockout Threshold Hysteresis			400mV	
Output Voltage Range		0.8VDC		34.8VDC
Standby Current	DC-DC OFF			12µA
Switching Frequency		1800kHz	2200kHz	2600kHz
	$T_{AMB} = 25^{\circ}C$	192mV	200mV	208mV
Feedback Voltage	$T_{AMB} = -40$ °C to $+125$ °C	184mV	200mV	216mV
Feedback Current	V <sub>FB</sub> = 820mV		30nA	100nA
Start-up Time		46ms		
Rise-time Rise-time	internal soft start		0.9ms	

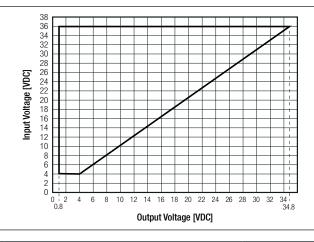
## **Typical Application**



C1 (C <sub>IN</sub> )	R <sub>1</sub>	R <sub>2</sub>	R <sub>3</sub>	C <sub>2</sub> (C <sub>OUT</sub> )
10μF	1ΜΩ	100kΩ	400m $Ω$	10μF

The typical performance and circuit waveforms are shown in the **Typical Performance Characteristics** section. For more device applications, please refer to the related evaluation board datasheet <a href="https://example.com/repressions-repressi

## SAFE OPERATING AREA



## CTRL OPERATING CONDITIONS (V<sub>IN</sub>= 36VDC, I<sub>OUT</sub>= 1.5A T<sub>AMB</sub>= +25°C; tested with RECOM evaluation module: RPY-1.5Q-EVM-1 unless otherwise stated)

Parameter	Condition	Min.	Тур.	Max.
CTRL Rising Threshold		1.1VDC	1.45VDC	1.8VDC
CTRL Falling Threshold		0.7VDC	1VDC	1.3VDC
CTRL Input Current	V <sub>CTRL</sub> = 2VDC		5nA	10nA
CTRL Frequency Range (4)		100Hz		2kHz
CTRL OFF delay		10ms	25ms	50ms

#### Notes:

Note4: Apply an external, 100Hz to 2kHz, PWM waveform to EN/DIM for PWM dimming. The average current is proportional to the PWM duty. The minimum amplitude of the PWM signal is 1.8V.



## **Series**

## Specifications

FAULT					
Parameter	Condition	Min.	Тур.	Max.	
FAULT Over Voltage Detection			140%		
FAULT Over Voltage Detection Hysteresis			20%		
FAULT Detection Delay			10µs		
FAULT Sink Current Capability			0.4VDC		
FAULT Leakage Current			100nA		

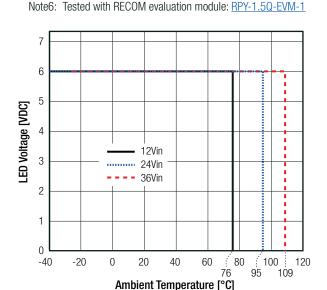
The RPY-1.5Q has fault indication (FAULT) which is the open drain of a MOSFET and should be connected to VCC or another voltage source through a resistor (e.g.  $100k\Omega$ ). FAULT is pulled high during normal operation. During the error conditions of output short circuit, open circuit, or thermal shutdown, FAULT is pulled down to indicate a fault status.

THERMAL OPERATING CONDITIONS (V <sub>IN</sub> = 36VDC, I <sub>OUT</sub> = 1.5A; tested with RECOM evaluation module: RPY-1.5Q-EVM-1 unless otherwise stated)				
Parameter	Condition	Min.	Тур.	Max.
Operating Junction Temperature		-40°C		+125°C
The surrent have and are a	junction to ambient		46K/W	
Thermal Impedance	case to ambient		30K/W	
Thermal Shutdown	Junction Temperature= 170°C		auto recov	ery after cool down

#### Notes:

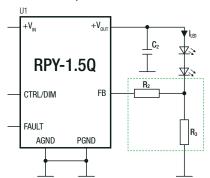
## **Thermal Derating**

 $(I_{OUT} = 1.5A)$ 



## **OUTPUT CURRENT SETTING**

The external resistor  $R_3$  divider sets the output current (see "*Typical Application*") and should be approximately 400m $\Omega$ .  $R_3$  can then be calculated with below equation. The resistor ( $R_2$ ) sets the feedback loop bandwidth. The lower the  $R_2$  is, the higher the bandwidth. A high BW may cause insufficient phase margin, resulting in loop instability. R3 Ensure that Sense resistor is capable of handling defined current. Thermal drift and resistor tolerance will have an impact on current stability.



#### **Calculation:**

$$I_{LED} = \frac{0.2VDC}{R_3}$$

## Example:

$$I_{LED} = \frac{0.2}{0.4} = 0.5$$

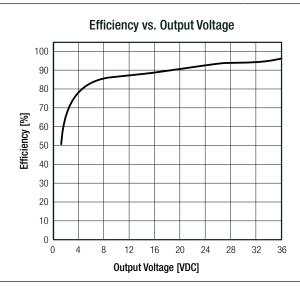
$V_{FB}$ [VDC]	I <sub>LED</sub> [A]	$R_2$ [k $\Omega$ ]	<b>R</b> <sub>3</sub> [Ω]
	0.35	220	0.57
0.2	0.5	200	0.4
	0.7	175	0.286
	1.05	150	0.19
	1.5	100	0.133

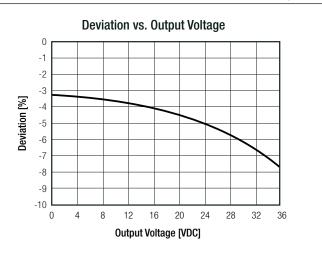


**Series** 

## Specifications

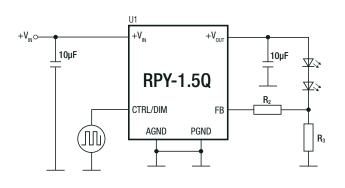
TYPICAL PERFORMANCE CHARACTERISTICS (V<sub>IN</sub>= 36VDC, I<sub>LED</sub>= 1.5A, T<sub>AMB</sub>= +25°C; tested with RECOM evaluation module: RPY-1.5Q-EVM-1)

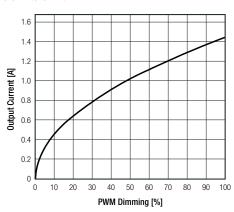


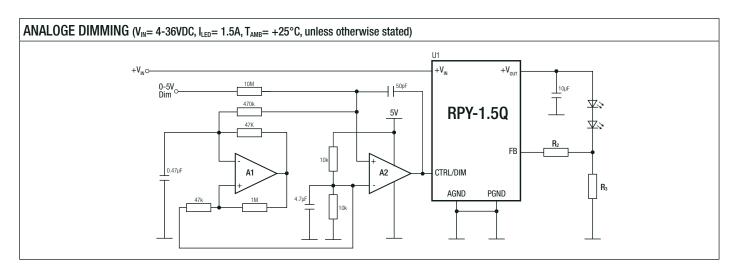


PWM DIMMING (V <sub>IN</sub> = 36VDC, I <sub>LED</sub> = 1.5A, T <sub>AMB</sub> = +25°C; tested with RECOM evaluation module: RPY-1.5Q-EVM-1 unless otherwise stated)				
Parameter	Condition	Min.	Тур.	Max.
CTRL/DIM frequency		100Hz		2kHz
PWM Voltage		1.8VDC		
PWM on time at start up		2s		

Dimming tested with RECOM EVM board RPY-1.5Q-EVM-1, with 100Hz to 2kHz and PWM waveform to CTRL/DIM.









## **Series**

## Specifications

ENVIRONMENTAL					
Parameter	Condition	Value			
FCD	human-body model (HBM), ANSI/ESDA/JEDEC JS-001	±2kV			
ESD	charged-device model (CDM), JEDEC JESD22-C101	±0.75kV			
Moisture Sensitive Level	MSL peak temp. (7)	Level 3, 260°C, 168hrs			
Notes:					
Note7: The Moisture S	Sensitivity Level rating is according to the JEDEC industry standard classifications and	l peak solder temperature			

## SAFETY AND CERTIFICATIONS

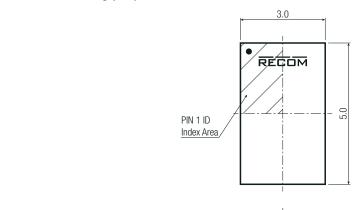
Certificate Type (Safety)	Standard
RoHS2	RoHS 2011/65EU + AM2015/863

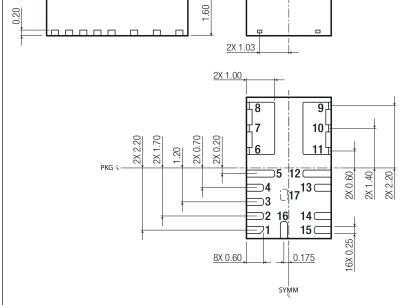
DIMENSION AND PHYSICAL CHARACTERISTICS				
Parameter	Туре	Value		
Material	case	plastic		
Dimension (LxWxH)		3.0 x 5.0 x 1.6mm		
Weight		0.095g		

## **Dimension Drawing (mm)**









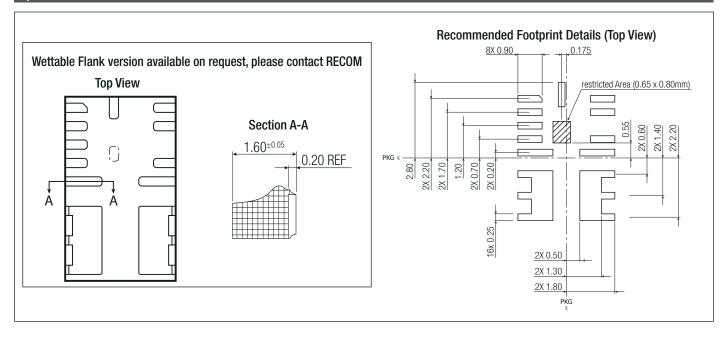
## **Pin Information**

Pin#	Function	Description		
1	FAULT	Open drain output fault indicator which is pulled low when the LED is short, open, or when thermal shutdown occurs.		
2	CTRL/DIM	CTRL/DIM control. Pull CTRL/DIM high to enable the RPY-1.5Q. Apply a 100Hz to 2kHz external clock to CTRL/DIM for PWM dimming.		
3	FB	Feedback Voltage		
4	VCC	Internal 4.9VDC LDO output.		
5	AGND	Analog ground. Reference ground of logic circuit.  AGND is connected to PGND internally.		
6, 7, 8, 12	SW	Switch node. Connect 6, 7, and 8 to large copper pad for optimal heat dissipation.		
9, 10, 11	Vout	Power Output. Connect LED+ to VOUT. An output capacitor is needed between VOUT and PGND		
13	DNC	Do not connect. Must be soldered to an isolated pad.		
14, 15	PGND	ower Ground. Connect these pins to the power ground plane on the PCB.		
16	Vin	Input Voltage. Connect a low-ESR low-inductance external bypass capacitor between this pin and GND as close to the pins as possible.		
17	DNC	Do not connect. Leave Floating		
Tolerances: according to JEDEC MO-220 Lead side is wettable and coplanarity shall be 0.10mm max. (optional)				



## **Series**

## Specifications

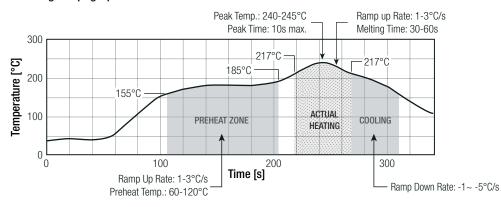


## **SOLDERING**

Profile Feature	PB-Free Assembly
Preheat	
minimum Temperature (TS_min)	155°C
maximum Temperature (TS_max)	245°C
Time (tS)	100s-300s
Liquidus	
Temperature (TL)	217°C
Time (tL)	30-60s
Peak Temperature (TP)	245°C
Time remaining around Peak Temperature	10s
max Ramp Down Rate (from Ts_max to TP)	5K/s
max Ramp Up Rate	3K/s
max time from 25°C to Peak Temperature (TP)	8min

1	Pb-Free assembly is recommended according ro JEDEC J-STD020.
2	Ensure that the peak reflow temperature does not exceed 240°C ±5°C as per JEDEC J-STD020
3	The reflow time period during peak temperature of 240°C $\pm 5$ °C should not exceed 30 seconds.
4	Reflow time above liquids (217°C) should not exceed 150 seconds.
5	For solder paste use a standard SAC Alloy such as SAC 305, type 3 or higher.
6	Other soldering methods (e.g. vapor-phase) are not verified and have to validate by the customer on his own risk.

#### Soldering temp. graph





**Series** 

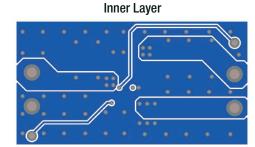
## **Specifications**

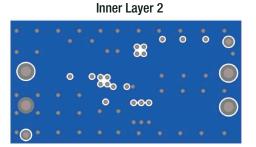
#### PCB LAYOUT SUGGESTION

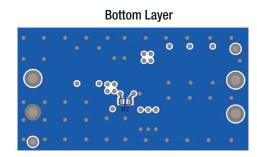
Efficient PCB layout, especially of the input capacitor placement, is critical for stable operation. For best results follow the guidelines below.

- 1. Connect a large ground plane to PGND pins 14 and 15 directly. If the bottom layer is a ground plane, add vias near GND.
- 2. Ensure that the high-current paths at GND and VIN have short, direct, and wide traces.
- 3. Place the ceramic input capacitor close to VIN and GND.
- 4. Keep the connection of the input capacitor and VIN as short and wide as possible.
- 5. Place the external feedback resistors close to the chip.
- 6. Use multiple vias to connect power planes to internal layers.

# Top Layer VIN GND LED-







PACKAGING INFORMATION					
Parameter	Туре	Value			
	reel (diameter + width)	Ø177.8 x 12.4mm			
Packaging Dimension (LxWxH)	tape and reel (carton)	260.0 x 240.0 x 60.0mm			
	moisture barrier bag ("-CT")	100.0 x 100.0 x 30mm			
Dealessing Overtity	tape and reel	500pcs			
Packaging Quantity	moisture barrier bag ("-CT")	10pcs			
Tape Width		12mm			
Storage Temperature Range		-65°C to +150°C			

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